SPECIFICATION FOR LCD MODULE

Model No. TM162JBAG

Prepared by: Date: Checked by: **Date:** Verified by: Date: Approved by: Date:

TIANMA MICROELECTRONICS CO., LTD

REVISION RECORD

Date	Ver.	Ref. Page.	Revision No.	Revision	Item

1/22 Rev. 1.0

1. General Specifications:

1.1 Display type: STN

1.2 Display color*:

Display color: Blue-Black
Background: Yellow-Green

1.3 Polarizer mode: Reflective/Positive

1.4 Viewing Angle: 6:00

1.5 Driving Method: 1/16 Duty 1/5 Bias

1.6 LCD Operating Voltage: 2.4 - 5.5V

1.7 Logic Voltage: 5V

1.8 Without Backlight

1.9 Controller: S6A0032X01-B0CY

1.10 Display Fonts: 5 × 8 dots (1 Character)

1.11 Data Transfer: 8 Bits Parallel

1.12 Operating Temperature: 0----+50

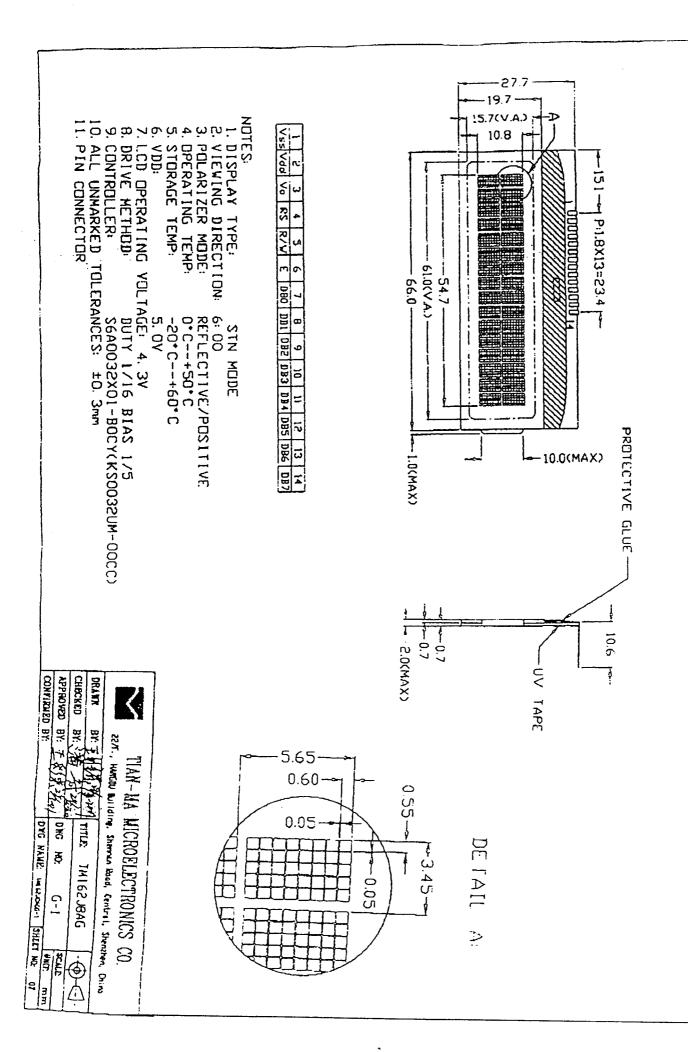
Storage Temperature: -20----+60

1.13 Outline Dimensions: Refer to outline drawing on next page

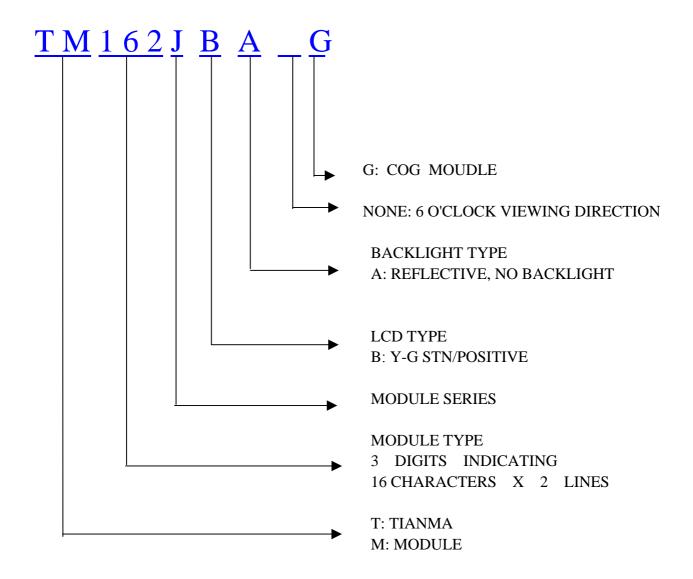
1.14 Dot Matrix: 16 Characters X 2 Lines

1.15 Dot Size: 0.55X0.60(mm)
1.16 Dot Pitch: 0.60X0.65(mm)
1.17 Weight: 20g (Approx)

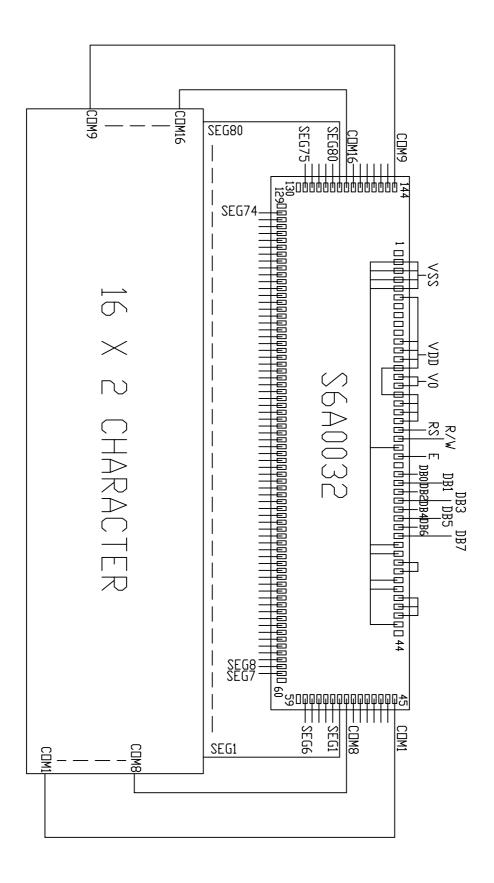
^{*} Color tone is slightly changed by temperature and driving voltage.



3. LCD Module Part Numbering System



4. Circuit Block Diagram



5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remark	
Power Supply Voltage	V _{DD} - V _{SS}	-0.3	7.0	V		
LCD Driving Voltage	VLCD	-0.3	13.0	v		
Operating Temperature Range	Тор	0	+50		No	
Storage Temperature Range	Тѕт	-20	+60		Condensation	

6. Electrical Specifications and Instruction Code

6.1 Electrical characteristics

Iten	n	Symbol	Min.	Min. Typ. Max.		
Supply V (Logi	_	V _{DD} - V _{SS}	1	5.0	-	V
Supply V (LCD D		Vlcd	- 4.5 -			V
Input	High	V _{IH} (V _{DD} =5.0)	$0.7V_{DD}$	-	V _{DD} +0.3	V
Signal Voltage	Low	$V_{\text{\tiny IL}}$ (V_{DD} =5.0)	-0.3	-	$0.2V_{DD}$	V
Supply current (Logic)		I_{DD} (V_{DD} - V_{SS} =5.0)	-	-	500	uA

6.2 Interface Signals

Pin No.	Symbol	Level	Description
1	V _{SS}	0V	Ground
2	$V_{ m DD}$	5.0V	Power supply voltage
3	V_{0}	4.5V	Power supply voltage for LCD
4	RS	H/L	Selects registers (H: Data, L: Instruction)
5	R/W	H/L	Selects read or write (H: Read, L: Write)
6	E	H/L	Read/write enable signal
7	DB0	H/L	Data bit0
8	DB1	H/L	Data bit1
9	DB2	H/L	Data bit2
10	DB3	H/L	Data bit3
11	DB4	H/L	Data bit4
12	DB5	H/L	Data bit5
13	DB6	H/L	Data bit6
14	DB7	H/L	Data bit7

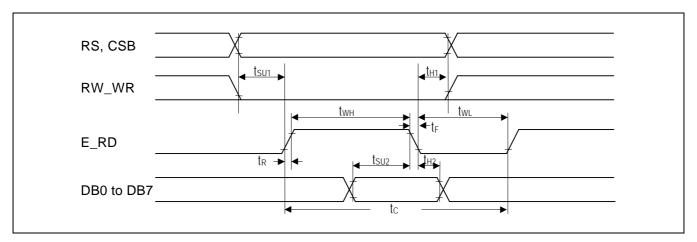
6.3 Interface Timing Chart

AC Characteristics(V_{DD}=2.4V~5.5V,Ta=-30~+85°C)

6800-series MPU Interface & Write Instruction

AC Characteristics (6800-series Write Instruction)

Condition	Characteristic	Symbol	Min.	Тур.	Max.	Unit
	E cycle time	t _C	650		-	
	Pulse rise / fall time	t _R , t _F	-	-	25	
	E pulse width high	t _{WH}	450	-	-	
VDD = 2.4V to 3.6V,	E pulse width low	t _{WL}	150	-	-	20
Ta = -30 to +85 $^{\circ}$ C	RS and CSB setup time	t _{SU1}	60	-	-	ns
	RS and CSB hold time	t _{H1}	30	-	-	
	DB setup time	t _{SU2}	100	-	-	
	DB hold time	t _{H2}	50	-	-	
	E cycle time	t _C	350		-	
	Pulse rise / fall time	t_R , t_F	-	-	25	
	E pulse width high	t _{WH}	250	-	-	
$VDD = 3.6V \text{ to } 5.5V,$ $Ta = -30 \text{ to } +85 ^{\circ}\text{C}$	E pulse width low	t_{WL}	100	-	-	20
1a = -30 to +85 C	RS and CSB setup time	t _{SU1}	40	-	-	ns
	RS and CSB hold time	t _{H1}	10	-	-	
	DB setup time	t _{SU2}	40	-	-	
	DB hold time	t _{H2}	10	-	-	

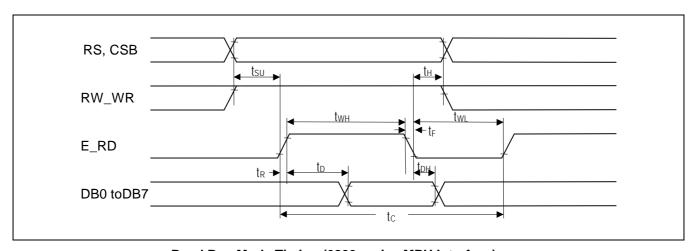


Write Bus Mode Timing (6800-series MPU Interface)

6800-series MPU Interface & Read Instruction

AC Characteristics (6800-series Read Instruction)

Condition	Characteristic	Symbol	Min.	Тур.	Max.	Unit
	E cycle time	t _C	650		-	
	Pulse rise / fall time	t_R, t_F	-	-	25	
	E pulse width high	t _{WH}	450	-	-	
VDD = 2.4V to 3.6V,	E pulse width low	t _{WL}	150	-	-	
Ta = -30 to +85 °C	RS and CSB setup time	t _{SU}	60	-	-	ns
	RS and CSB hold time	t _H	30	-	-	
	DB output delay time	t _D	-	-	360	
	DB output hold time	t _{DH}	20	-	-	
	E cycle time	t _C	350		-	
	Pulse rise / fall time	t_R, t_F	-	-	25	
	E pulse width high	t _{WH}	250	-	-	
VDD = 3.6V to 5.5V,	E pulse width low	t _{WL}	100	-	-	20
Ta = -30 to +85 $^{\circ}$ C	RS and CSB setup time	t _{SU}	40	-	-	ns
	RS and CSB hold time	t _H	10	-	-	
	DB output delay time	t _D	-	-	120	
	DB output hold time	t _{DH}	10	-	-	



Read Bus Mode Timing (6800-series MPU Interface)

6.4 Instruction Code

INSTRUCTION DESCRIPTION

Instruction Table

Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description
*Clear display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM and set DDRAM address to "00H" from AC
Return home	0	0	0	0	0	0	0	0	1	-	DDRAM address is set to 00h from AC and the cursor returns to 00h position. The contents of DDRAM are not changed.
Entry mode set	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and enable the shift of entire display
Display ON / OFF control	0	0	0	0	0	0	1	D	С	В	Set display (D), cursor (C), and blinking of cursor (B) ON / OFF control
Cursor or display shift	0	0	0	0	0	1	S/C	R/L	-	-	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data
Function set	0	0	0	0	1	DL	ı	ı	ı	1	Set interface data length (DL: 4-bit / 8-bit) instruction
CGRAM address set	0	0	0	1	0	0	А3	A2	A1	A0	Set CGRAM address in address counter.
DDRAM address set	0	0	1	A6	A5	A4	А3	A2	A1	A0	Set DDRAM address in address counter.
Read busy flag and address	0	1	BF	A6	A5	A4	А3	A2	A1	A0	Whether in internal operation or not can be known by reading BF, The contents of address counter can also be read
Write data	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into DDRAM / CGRAM
Read data	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from DDRAM / CGRAM

("-": Don't care)

NOTES:

^{1.} Instruction execution time depends on the internal process time of KS0032, therefore it is necessary to provide a time larger than one MPU interface cycle time (tc) between execution of two successive instructions.

^{2. &}quot;Clear Display" instruction has 850μs execution time (when fosc = 40.0kHz), so check the Busy flag or wait for more than 850μs after using "Clear Display" instruction.

6.5 Character generator ROM(S6A0032)

CHARACTER GENERATOR ROM (CGROM)

CGROM has 5×8 -dot 254 characters. The CGROM character code 00h and 01h are CGRAM character data area.

CGROM Character Code (00)



7. Optical Characteristics

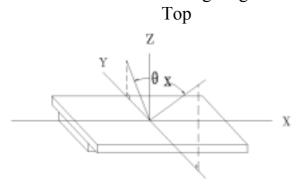
7.1 Optical Characteristics

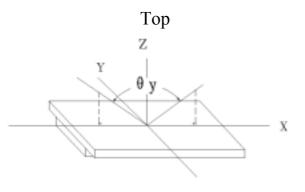
Ta=25

Item		Symbol Condition		dition	Min.	Тур.	Max.	Unit
Viewing Angle		х	Cr≥2	y=0 °	-35		20	Dag
		у	Cr22	_x =0 °	-30)	30	Deg
Contrast 1	Ratio	Cr	x=0 ° y=0 °		4.0	-	-	
Response	Turn on	Ton	x=0 ° y=0 °		-	-	250	
Time	Turn off	$T_{ m off}$	y=	=0 °	-	-	250	ms

7.2 Definition of Optical Characteristics

7.2.1 Definition of Viewing Angle



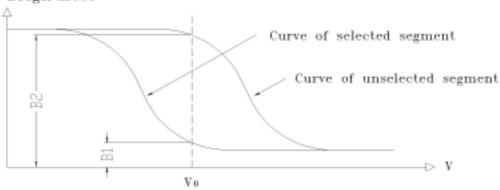


Bottom

Bottom

7.2.2 Definition of Contrast Ratio





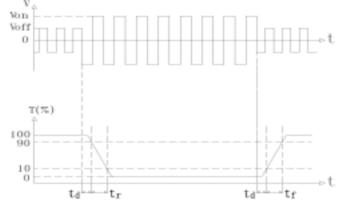
Contrast Ratio = $B2/B1 = \frac{\text{unselected state brightness}}{\text{selected state brightness}}$

Measuring Conditions:

1) Ambient Temperature: 25

2) Frame frequency: 78Hz

7.2.3 Definition of Response time



Turn on time: $t_{on} = t_d + t_r$

Turn off time: $t_{off} = t_d + t_f$

Measuring Condition:

1) Operating Voltage: 3.3V

2) Frame frequency: 78Hz

8. Reliability

8.1 Content of Reliability Test

Ta=25

No.	Test Item	Content of Test	Test condition
1	High Temperature Storage	Endurance test applying the high storage temperature for a long time	60
2	Low Temperature Storage	Endurance test applying the low storage temperature for a long time	96H -20 96H
3	High Temperature Operation	Endurance test applying the electric stress (voltage & current) and the thermal stress to the element for a long time	50 96H
4	Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time	0 96Н
5	High Temperature /Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time	40 90%RH 96H
6	Temperature Cycle	Endurance test applying the low and high temperature cycle -20 25 60 25 30min 5min 30min 5min 1 cycle	-20 /60 10 cycles
7	Vibration Test (package state)	Endurance test applying the vibration during transportation	10Hz~150Hz, 50m/s², 40min
8	Shock Test (package state)	Endurance test applying the shock during transportation	Half- sine wave, 100m/s ² , 11ms
9	Atmospheric Pressure Test	Endurance test applying the atmospheric pressure during transportation by air	40kPa 16H

8.2 Failure Judgment Criterion

Criterion			To	est l	Iter	n N	0.			Failure Judgement Criterion
Item	1	2	3	4	5	6	7	8	9	randre Judgement Criterion
Basic Specification	1	1	1	1	1	7	1	√	√	Out of the basic Specification
Electrical specification	√	1	1	1	1					Out of the electrical specification
Mechanical Specification							1	√		Out of the mechanical specification
Optical Characteristic	V	1	1	1	1	V			√	Out of the optical specification
Note	For test item refer to 8.1									
Remark	Basic specification = Optical specification + Mechanical specification									

9. QUALITY LEVEL

Examination	At Ta=25	Inspection					
or Test	(unless otherwise stated)	Min.	Max.	Unit	IL	AQL	
External Visual Inspection	Under normal illumination and eyesight condition, the distance between eyes and LCD is 25cm.	See A _J	opendix	II	Major 1.0 Minor 2.5		
Display Defects	Under normal illumination and eyesight condition, display on inspection.	See A _J	opendix	В	II	Major 1.0 Minor 2.5	

Note: Major defects: Open segment or common, Short, Serious damages, Leakage

Miner defects: Others

Sampling standard conforms to GB2828

10. Precautions for Use of LCD Modules

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

- 10.2 Storage precautions
- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature: $0 \sim 40$

Relatively humidity: 80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

Appendix A

Inspection items and criteria for appearance defects

Items	Contents			Criteria		
Protective Glue		No clear defe	cts			
Cover Tape	Covering all of the chip and no clear crimple					
Leakage	Not permitted					
Rainbow	According to	the lir	nit specimen			
Wrong polarizer attachment		Not permitted				
Polarizer	Bubble between	Not counted		Max. 3 defects allowed		
	polarizer and glass	ф<0.3mm		0.3mm \$\phi\$ 0.5r	nm	
	Scratches of polarizer	According to the limit specimen				
Black spot		Not counted	Max	. 3 spots allowed		
(in viewing area)	İ	X<0.20mm	0.20	0.20mm X 0.5mm Max		
arca)		X=(a+b)/2			spots (lines)	
Black line (in viewing	1	Not counted	Max	. 3 lines allowed	allowed	
area)	t b	a<0.02mm	0.02	mm a 0.05mm		
	-			b 2.0mm		
Progressive cracks		Not permitted				

Appendix A

Inspection item and criteria for appearance defects (continued)

Items	Contents	Criteria					
Glass	Cracks on pads	a	b	ı	c	Max. 2	
	///-\\$/	3mm	W	V/5	T/2	Cracks allowed	
	b	2mm	V	V/5	T/2 <c<t< td=""></c<t<>		
	Cracks on contact side	a			b		
		3mm		T/2			
		2mm		7	T/2 <b<t< td=""><td></td><td></td></b<t<>		
		C shall be not reach the seal area			Max. 2 cracks	Max. 5 cracks allowed	
	Cracks on non-contact side	a		b		allowed	
	O SW -	3mm		T/2			
		2m	m	7	T/2 <b<t< td=""><td></td><td></td></b<t<>		
		C 0.5mm					
	2"	d SW/3					
	Corner cracks	e<2.0mm ²			Max. 3 cracks allowed		
	f-P	f<2.0mm ²					

Appendix BInspection items and criteria for display defects

Items		Contents	Criteria				
Open segment or open common			Not permitted				
Short			Not permitted				
Wrong viewing angle			Not permitted				
Contrast radio uneven			According to the limit specimen				
Crosstalk			According to the limit specimen				
	+ 1-a		Not counted	Max.3 dots allowed			
			X<0.1mm	0.1mm X 0.2mm			
Pin holes		X=(a+b)/2	Max.3 dots				
and cracks in segment	T T T	Not counted	Max.2 dots allowed	allowed			
(DOT)		A<0.1mm	0.1mm A 0.2mm				
			D<0.25mm				
Black spot	ot		Not counted	Max.3 spots allowed			
(in viewing area)		X<0.1mm	0.1mm X 0.2mm				
		X=(a+b)/2	Max.3 spots (lines)				
Black line		Not counted	Max.3 lines allowed	allowed			
(in viewing area)		a<0.02mm	0. 02m a 0.05mm b 0.5mm				

Appendix B

Inspection items and criteria for display defects (continued)

Items	Content	Criteria				
		Not counted	Max. 2 defects allowed			
		x < 0.1mm	0.1mm x 0.2mm			
	'	x=(a+b)/2				
		Not counted	Max. 1 defects allowed	Max.3 defects allowed		
Transfor- mation of segment		a < 0.1mm	0.1mm a 0.2mm D>0			
		Max.2 defects 0.8W a 1.2 a=measured va W=nominal va				